

1204 Package With Right Angle Lens

Full-Color Chip LED

Technical Data Sheet

Part No.: S117PRGBC



Features:

Package in 8mm tape on 7" diameter reel.
Full-Color Type.
Compatible with automatic placement equipment.
Compatible with infrared and vapor phase reflow solder process.
The product itself will remain within RoHS compliant Version.

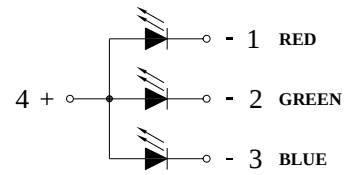
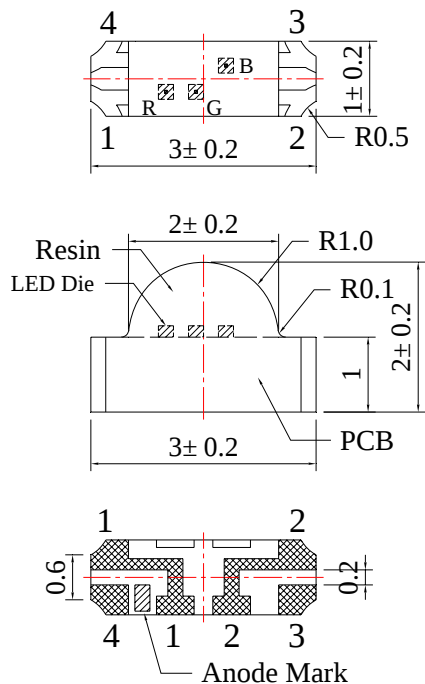
Descriptions:

The S117P SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
Besides, lightweight makes them ideal for miniature applications .etc.

Applications:

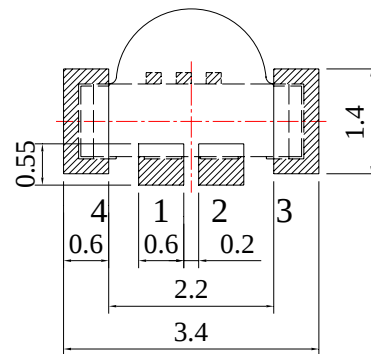
Automotive: Backlighting in dashboard and switch.
Telecommunication: Indicator and backlighting in telephone and fax.
Flat backlight for LCD, switch and symbol.
Indoor signboard use.
General use.

Package Dimension:



Polarity

Recommended Soldering Pad Dimensions



Unit: mm
Tolerance: $\pm$ 0.10mm

Part No.	Chip Material		Lens Color	Source Color
S117PRGBC	R	AlGaInP	Water Clear	Hyper Red
	G	InGaN		Pure Green
	B	InGaN		Blue

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm$ 0.10mm (.004") unless otherwise specified.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings at Ta=25

Parameters	Symbol	Emitting Color	Max.	Unit
Power Dissipation	PD	Hyper Red	60	mW
		Pure Green	95	
		Blue	95	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	Hyper Red	100	mA
		Pure Green	100	
		Blue	100	
Continuous Forward Current	IF	Hyper Red	25	mA
		Pure Green	25	
		Blue	25	
Reverse Voltage	VR		5	V
Electrostatic Discharge (HBM)	ESD	Hyper Red	2000	V
		Pure Green	400	
		Blue	400	
Operating Temperature Range	Topr		-40 to +80	
Storage Temperature Range	Tstg		-40 to +85	
Soldering Temperature	Tstd		260 for 5 Seconds	

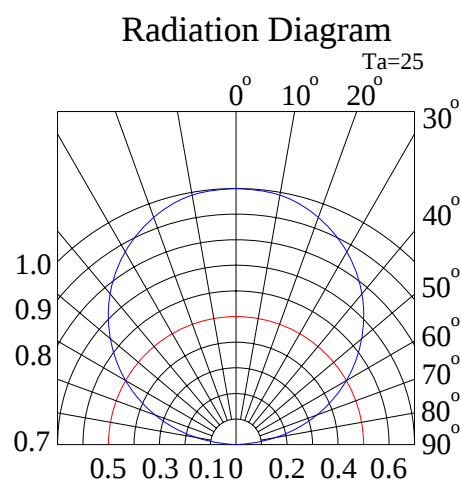
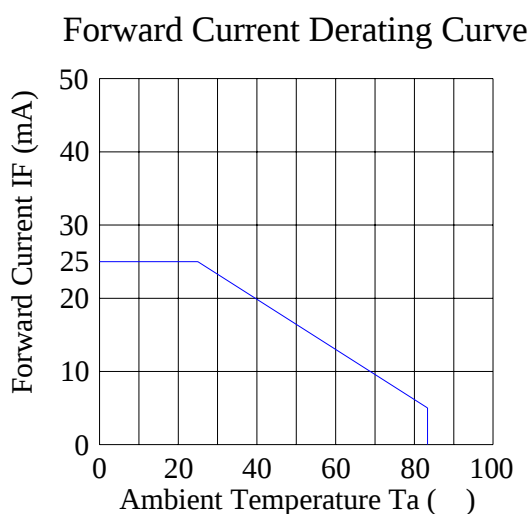
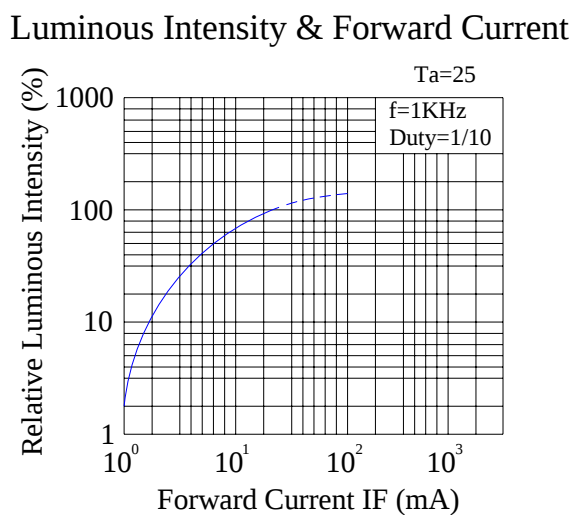
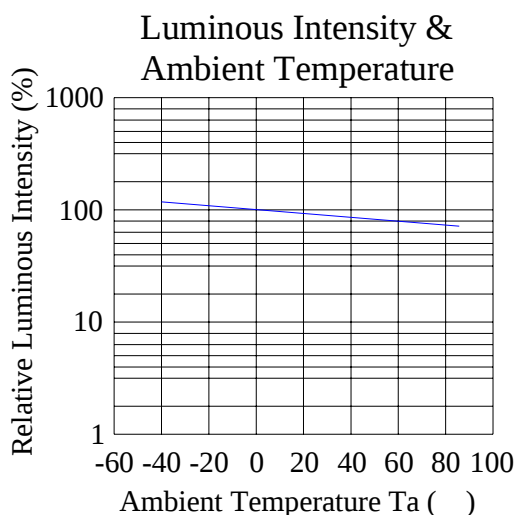
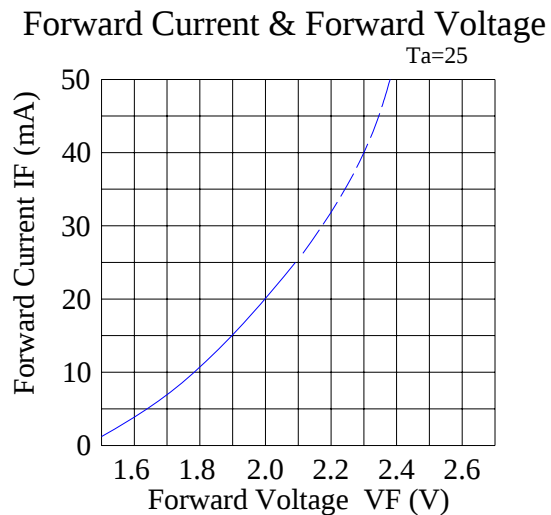
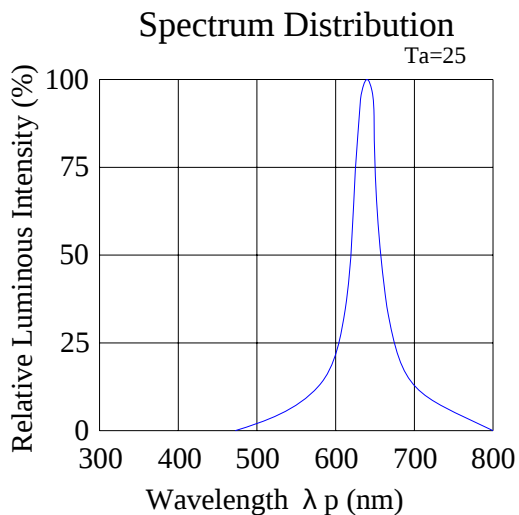
Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Emitting Color	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	Hyper Red	80	120	---	mcd	IF=20mA (Note 1)
		Pure Green	200	300	---		
		Blue	40	75	---		
Viewing Angle	$2\theta_{1/2}$	Hyper Red	---	120	---	Deg	IF=20mA (Note 2)
		Pure Green	---	120	---		
		Blue	---	120	---		
Peak Emission Wavelength	λ_p	Hyper Red	---	632	---	nm	IF=20mA
		Pure Green	---	520	---		
		Blue	---	468	---		
Dominant Wavelength	λ_d	Hyper Red	---	624	---	nm	IF=20mA (Note 3)
		Pure Green	---	525	---		
		Blue	---	470	---		
Spectral Line Half-Width	λ	Hyper Red	---	20	---	nm	IF=20mA
		Pure Green	---	35	---		
		Blue	---	25	---		
Forward Voltage	VF	Hyper Red	1.60	2.00	2.40	V	IF=20mA
		Pure Green	2.80	3.40	3.80		
		Blue	2.80	3.40	3.80		
Reverse Current	IR	Hyper Red	---	---	10	μA	$V_R=5V$
		Pure Green			50		
		Blue			50		

Notes:

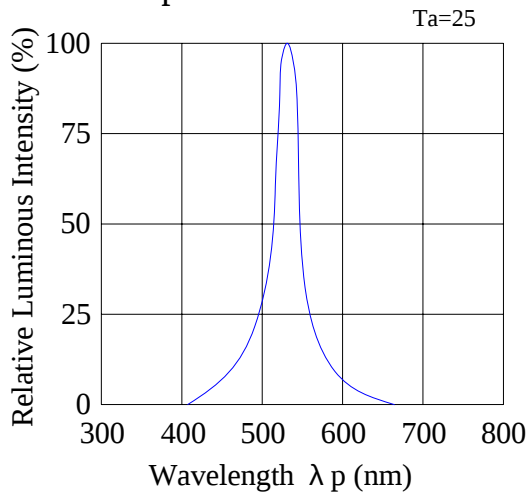
1. Luminous Intensity Measurement allowance is $\pm 10\%$.
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength (λ_d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Typical Electrical / Optical Characteristics Curves
(25 Ambient Temperature Unless Otherwise Noted)
Hyper Red:

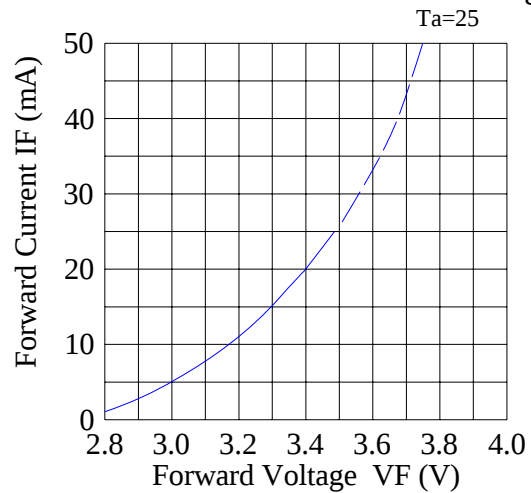


Pure Green:

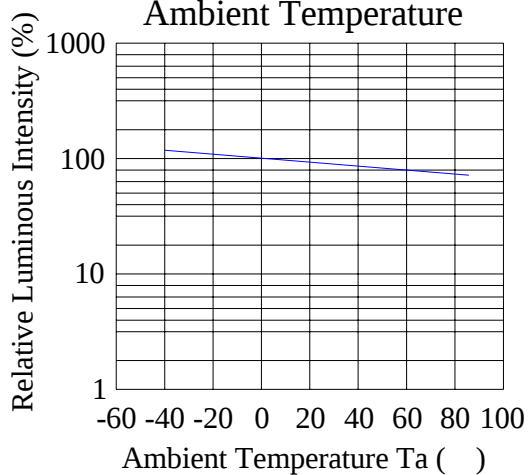
Spectrum Distribution



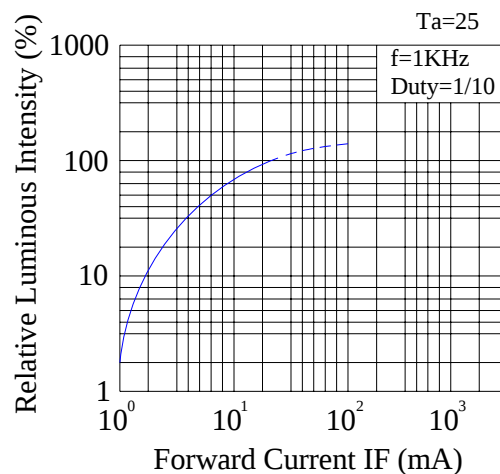
Forward Current & Forward Voltage



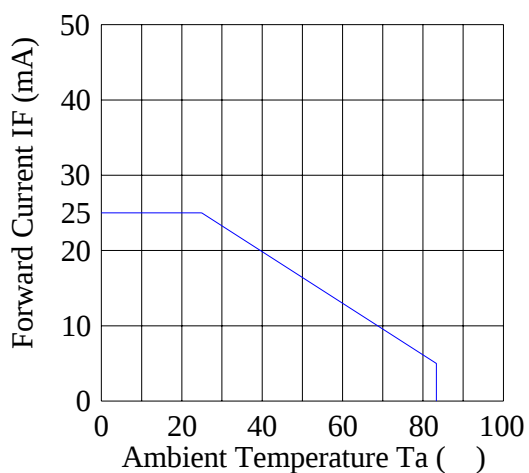
Luminous Intensity & Ambient Temperature



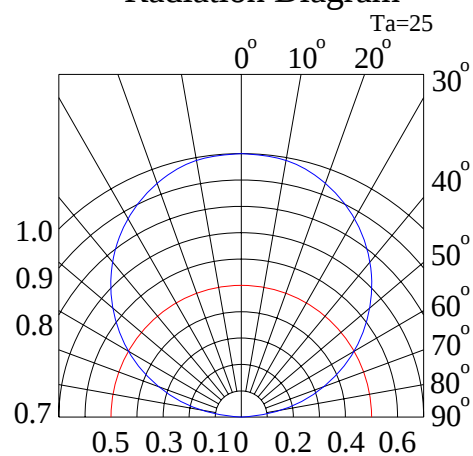
Luminous Intensity & Forward Current



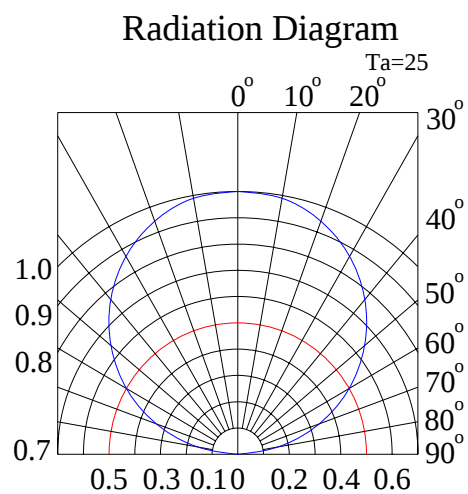
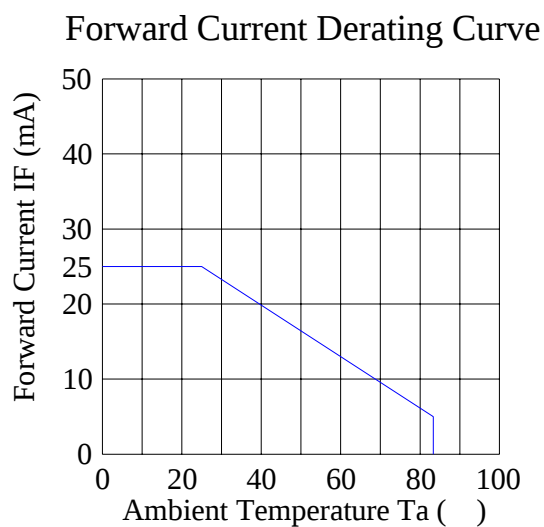
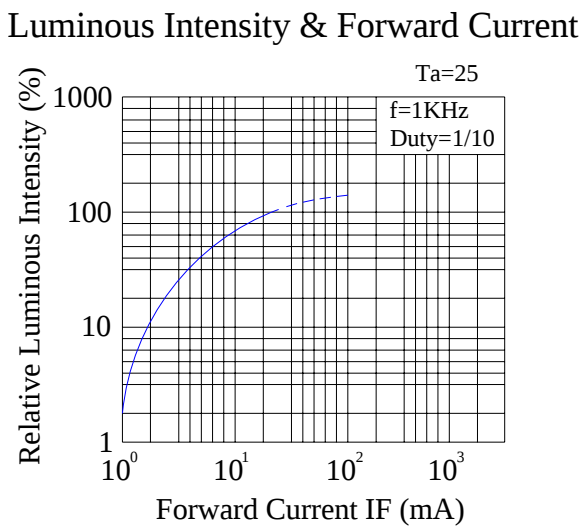
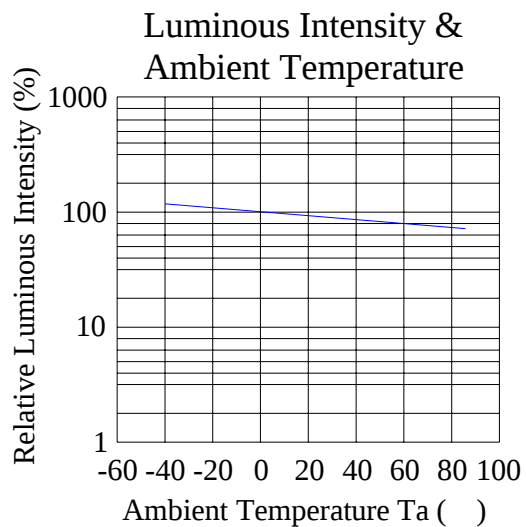
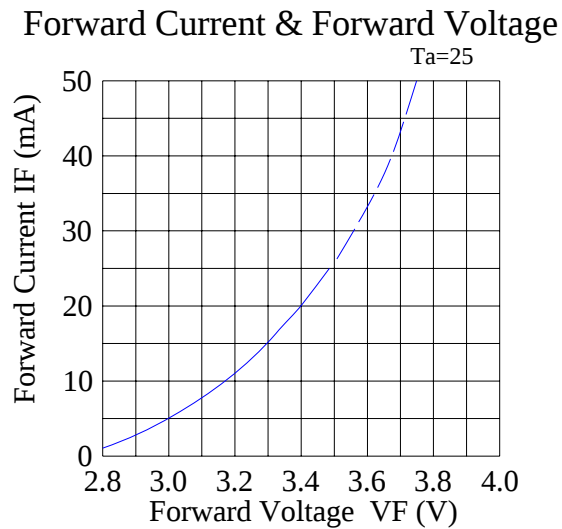
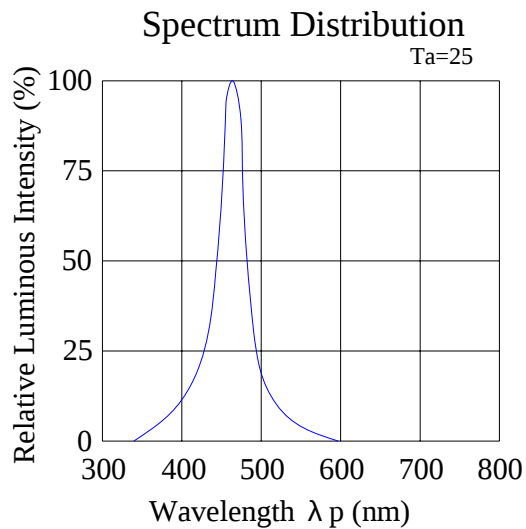
Forward Current Derating Curve



Radiation Diagram



Blue:



Reliability Test Items and Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5 , Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H: +100 5min f 10 sec L: -10 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H: +100 15min f 5min L: -40 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85 /85%RH	25pcs	0/1

2) Criteria for Judging the Damage:

Item	Symbol	Test Conditions	Criteria for Judgment	
			Min	Max
Forward Voltage	VF	IF=20mA	---	F.V.*)×1.1
Reverse Current	IR	VR=5V	---	F.V.*)×2.0
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7	---

*) F.V.: First Value.

Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30 °C or less and 80%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30 °C or less and 60%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture adsorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5 °C for 24 hours.

3. Soldering Condition

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoid the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Wave Soldering	
Temperature	300 °C Max.	Pre-heat	100 °C Max.
Soldering Time	3 sec. Max. (one time only)	Pre-heat Time	60 sec. Max.
		Solder Wave	260 °C Max.
		Soldering Time	5 sec. Max.

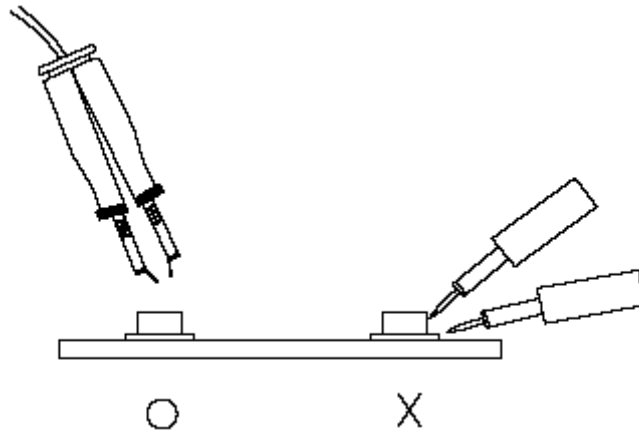
Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260 °C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.